

SID

Factory: Rot am See

Article:

ML6

Provided:

Customer:

Date:

28.04.2026

WÜRTH
ELEKTRONIK
MORE THAN
YOU EXPECT

Processtechnology: B: undefined

Material Text	Mat. Nr.	µm	Stackup	Process overview
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C-RS Panasonic R-F770-ED 18-50-00	50200950	<div>18</div> <div>50</div>	VS	<div>1</div> <div></div>	
A-RAS-FR4-PP-106-H72-TG170-LowFlow-EM...	50203100	<div>50</div>		<div>2</div> <div></div>	A01
C-RS-FR4-ML-0.254mm-018+018-TG150-HF-...	50203053	<div>18</div> <div>254</div> <div>18</div>	L2	<div>3</div> <div></div>	A02
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	<div>110</div>		<div>4</div> <div></div>	B00
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	<div>0</div>		<div>5</div> <div></div>	
C-RS-FR4-ML-0.254mm-018+018-TG150-HF-...	50203053	<div>18</div> <div>254</div> <div>18</div>	L4	<div>6</div> <div></div>	A03
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	<div>57</div>		<div>7</div> <div></div>	
A-RS Kupferfolie-018my 330x490mm	50200238	<div>18</div>	RS	<div>8</div> <div></div>	

Thickness after Pressing

B00:

890 µm

Tol+:

100 µm

Tol-:

100 µm

Dmax:

990 µm

Dmin:

790 µm

Thickness over all

0 µm

Tol+:

0 µm

Tol-:

0 µm

Dmax:

0 µm

Dmin:

0 µm

Demand for customer

Thickness (D):

1000 µm

Tol+:

100 µm

Tol-:

100 µm

Dmax:

1100 µm

Dmin:

900 µm

Measuring point:

(05) over SM and galv. Cu; both sides

nominal:

883 µm

Version 1.2.20.35

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